



CD4053 (LX) Triple 2-channel Analog Multiplexer/Demultiplexer

Product Specification

Specification Revision History:

Version	Date	Description
2022-06-A1	2022-06	New
2023-04-B1	2023-04	Update the template



Contents

1、General Description.....	3
2、Block Diagram And Pin Description	5
2.1、Block Diagram	5
2.2、Pin Configurations.....	6
2.3、Pin Description.....	6
2.4、Function Table.....	7
3、Electrical Parameter	7
3.1、Absolute Maximum Ratings.....	7
3.2、Recommended Operating Conditions	8
3.3、Electrical Characteristics.....	8
3.3.1、DC Characteristics 1	8
3.3.2、DC Characteristics 2.....	9
3.3.3、AC Characteristics 1.....	9
3.3.4、AC Characteristics 2.....	10
4、Testing Circuit	10
4.1、AC Testing Circuit 1	10
4.2、AC Testing Waveforms.....	11
4.3、AC Testing Circuit 2	12
4.4、On Resistance Waveform And Test Circuit	13
4.5、Measurement Points	13
4.6、Test Data	13
5、Package Information.....	14
5.1、DIP16	14
5.2、SOP16	15
5.3、TSSOP16.....	16
6、Statements And Notes	17
6.1、The name and content of Hazardous substances or Elements in the product.....	17
6.2、Notes	17



1、General Description

The CD4053 is a triple single-pole double-throw (SPDT) analog switch, suitable for use as an analog or digital multiplexer/demultiplexer. Each switch has a digital select input (S_n), two independent inputs/outputs (nY_0 and nY_1) and a common input/output (nZ). All three switches share an enable input ($\bar{E}$). A HIGH on $\bar{E}$ causes all switches into the high-impedance OFF-state, independent of S_n .

V_{DD} and V_{SS} are the supply voltage connections for the digital control inputs (S_n and $\bar{E}$). The V_{DD} to V_{SS} range is 3V to 9V. The analog inputs/outputs (nY_0 , nY_1 , and nZ) can swing between V_{DD} as a positive limit and V_{EE} as a negative limit. $V_{DD}-V_{EE}$ may not exceed 9V. Unused inputs must be connected to V_{DD} , V_{SS} , or another input. For operation as a digital multiplexer/demultiplexer, V_{EE} is connected to V_{SS} (typically ground). V_{EE} and V_{SS} are the supply voltage connections for the switches.

Features:

- Wide supply voltage range from 3V to 9V
- Fully static operation
- 5V and 9V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40°C to $+125^{\circ}\text{C}$
- Packaging information: DIP16/SOP16/TSSOP16



Ordering Information:

Tube packing specifications:

Part number	Packaging form	Marking code	Tube quantity	Boxed tube quantity	Boxed quantity	Notes
CD4053BE (LX)	DIP16	CD4053BE	25 PCS/tube	40 tube/box	1000 PCS/box	Dimensions of plastic enclosure: 19.0mm×6.4mm Pin spacing: 2.54mm
CD4053BM (LX)	SOP16	CD4053BM	50 PCS/tube	200 tube/box	10000 PCS/box	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing: 1.27mm
CD4053PW (LX)	TSSOP16	CD4053	96 PCS/tube	200 tube/box	19200 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing: 0.65mm

Reel packing specifications:

Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes
CD4053BM (LX)	SOP16	CD4053BM	2500 PCS/reel	5000 PCS/box	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing:1.27mm
CD4053PW (LX)	TSSOP16	CD4053	5000 PCS/reel	10000 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing:0.65mm

Note: If the physical information is inconsistent with the ordering information, please refer to the actual product.

2、Block Diagram And Pin Description

2.1、Block Diagram

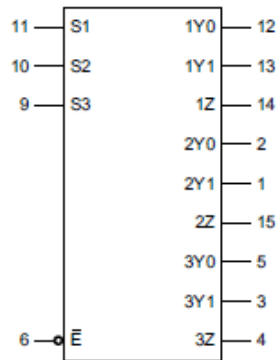


Figure 1. Logic symbol

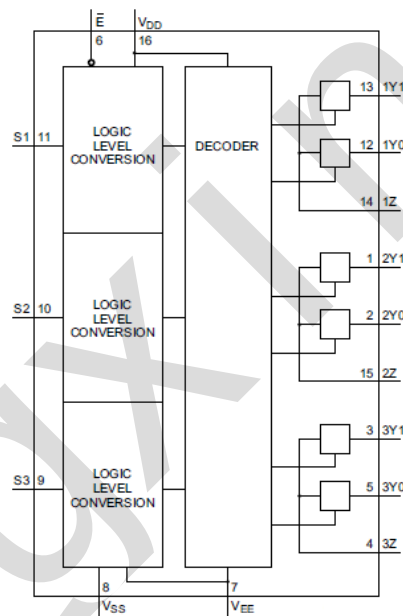


Figure 2. Functional diagram

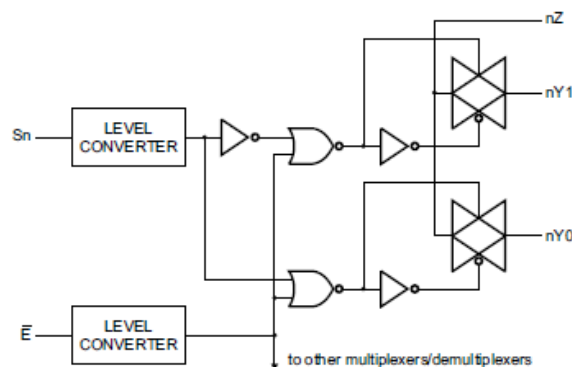


Figure 3. Logic diagram (one multiplexer/demultiplexer)

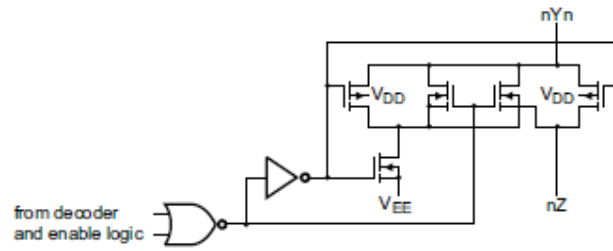
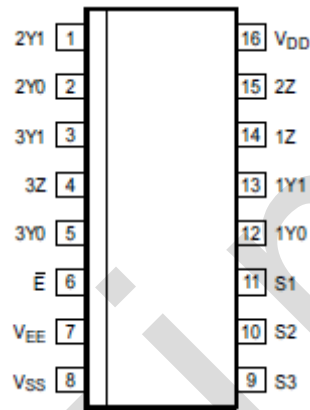


Figure 4. Schematic diagram (one switch)

2.2、Pin Configurations



2.3、Pin Description

Pin No.	Pin Name	Description
1	2Y1	independent input or output
2	2Y0	independent input or output
3	3Y1	independent input or output
4	3Z	independent output or input
5	3Y0	independent input or output
6	$\bar{E}$	enable input (active LOW)
7	V_{EE}	supply voltage
8	V_{SS}	ground (0V)
9	S3	select input
10	S2	select input
11	S1	select input
12	1Y0	independent input or output
13	1Y1	independent input or output
14	1Z	independent output or input
15	2Z	independent output or input
16	V_{DD}	supply voltage



2.4、Function Table

Input		Channel ON
$\bar{E}$	Sn	
L	L	nY0 to nZ
L	H	nY1 to nZ
H	X	switches off

Note: H=HIGH voltage level; L=LOW voltage level; X=don't care.

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(Voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V_{DD}	-	-0.5	+12	V
power supply range	$V_{DD}-V_{EE}$	-	-0.5	+12	V
static current	I_Q	$V_{DD}-V_{EE}=12V$	-	2	μA
input voltage	V_I	-	-0.5	$V_{DD}+0.5$	V
output high voltage current	$ I_{IH} $	$V_{DD}=5V, V_I=V_{DD}$	-	1	μA
output low voltage current	$ I_{IL} $	$V_{DD}=5V, V_I=0V$	-	1	μA
input and output voltage range	V_{IO}	-	$V_{EE}-0.5$	$V_{DD}+0.5$	V
input clamping current	I_{IK}	$V_I < -0.5V$ or $V_I > V_{DD}+0.5V$	-	± 20	mA
input and output clamp current	I_{IOK}	$V_{IO} < V_{EE}-0.5V$ or $V_{IO} > V_{DD}+0.5V$	-	± 20	mA
switch conduction current	I_T	$V_O = -0.5V$ to $V_{DD}+0.5V$	-	± 25	mA
VDD or GND current	I_{DD}, I_{GND}	-	-	± 50	mA
storage temperature	T_{stg}	-	-65	+150	$^{\circ}C$
total power dissipation	P_{tot}	-	-	500	mW
Soldering temperature	T_L	10s	DIP	245	$^{\circ}C$
			SOP/TSSOP	260	$^{\circ}C$



3.2、Recommended Operating Conditions

($T_{amb}=25^{\circ}\text{C}$; $R_L=10\text{k}\Omega$; $C_L=50\text{pF}$; $\bar{E}=V_{DD}$; $V_{IS}=V_{DD}=5\text{V}$.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V_{DD}	-	3	5	9	V
ambient temperature	T_{amb}	in free air	-40	-	+125	$^{\circ}\text{C}$
supply voltage	V_{EE}	-	-6.0	-	0	V
supply voltage	$V_{DD}-V_{EE}$	-	3.0	-	9.0	V
input voltage	V_I	-	0	-	V_{DD}	V
input and output voltage	V_{IO}	-	V_{EE}	-	V_{DD}	V
Input rise and fall time	t_r, t_f	-	-	-	1000	ns
		-	-	-	500	ns
		-	-	-	400	ns
input capacitance	C_I	-	-	-	7.5	pF

3.3、Electrical Characteristics

3.3.1、DC Characteristics 1

($T_{amb}=25^{\circ}\text{C}$, voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions (V)		$T_{amb}=25^{\circ}\text{C}$			Unit
				Min.	Typ.	Max.	
supply current	I_{DD}	$V_I=V_{DD}$ or $V_{SS}, I_O=0\text{A}$	$V_{DD}=5\text{V}$	-	-	20	μA
			$V_{DD}=9\text{V}$	-	-	40	μA
HIGH-level input voltage	V_{IH}	$ I_O <1\mu\text{A}$	$V_{DD}=5\text{V}$	3.5	-	-	V
			$V_{DD}=9\text{V}$	7.0	-	-	V
LOW-level input voltage	V_{IL}	$ I_O <1\mu\text{A}$	$V_{DD}=5\text{V}$	-	-	1.5	V
			$V_{DD}=9\text{V}$	-	-	3.0	V
input leakage current	I_I	$V_I=0\text{V}$ or $9\text{V}, V_{DD}=9\text{V}$		-	-	1.0	μA
3 state output leakage current	I_{OZ}	$V_{DD}=9\text{V}$	output to V_{DD}	-	-	1.6	μA
			output to V_{SS}	-	-	-1.6	μA
ON resistance (rail)	R_{ON}	$V_I=0\text{V}$ to $V_{DD}-V_{EE}$	$V_{DD}-V_{EE}=5\text{V}$	-	350	2500	Ω
			$V_{DD}-V_{EE}=9\text{V}$	-	80	245	Ω
		$V_I=0\text{V}$	$V_{DD}-V_{EE}=5\text{V}$	-	115	340	Ω
			$V_{DD}-V_{EE}=9\text{V}$	-	50	160	Ω
		$V_I=V_{DD}-V_{EE}$	$V_{DD}-V_{EE}=5\text{V}$	-	120	365	Ω
			$V_{DD}-V_{EE}=9\text{V}$	-	65	200	Ω
ON resistance mismatch between channels	ΔR_{ON}	$V_I=0\text{V}$ to $V_{DD}-V_{EE}$	$V_{DD}-V_{EE}=5\text{V}$	-	25	-	Ω
			$V_{DD}-V_{EE}=9\text{V}$	-	10	-	Ω
OFF-state leakage current	$I_{S(OFF)}$	$V_{SS}=V_{EE}, V_{DD}-V_{EE}=9\text{V}$	all channel off; $\bar{E}=V_{DD}$	-	-	1.0	μA
			any channel; $\bar{E}=V_{SS}$	-	-	1.0	μA

Note: On resistance waveform and test circuit see Figure 12 and Figure 13.



3.3.2、DC Characteristics 2

($T_{amb} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions (V)	$T_{amb} = -40^{\circ}\text{C}$		$T_{amb} = +85^{\circ}\text{C}$		$T_{amb} = +125^{\circ}\text{C}$		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
supply current	I_{DD}	$V_I = V_{DD}$ or V_{SS} , $I_O = 0\text{A}$	$V_{DD} = 5\text{V}$		-	20	-	150	μA
			$V_{DD} = 9\text{V}$		-	40	-	300	μA
HIGH-level input voltage	V_{IH}	$ I_O < 1\mu\text{A}$	$V_{DD} = 5\text{V}$		3.5	-	3.5	-	V
			$V_{DD} = 9\text{V}$		7.0	-	7.0	-	V
LOW-level input voltage	V_{IL}	$ I_O < 1\mu\text{A}$	$V_{DD} = 5\text{V}$		-	1.5	-	1.5	V
			$V_{DD} = 9\text{V}$		-	3.0	-	3.0	V
input leakage current	I_I	$V_I = 0\text{V}$ or 9V , $V_{DD} = 9\text{V}$	-	1.0	-	1.0	-	1.0	μA
3 state output leakage current	I_{OZ}	$V_{DD} = 9\text{V}$	output to V_{DD}		-	1.6	-	12.0	μA
			output to V_{SS}		-	-1.6	-	-12.0	μA

3.3.3、AC Characteristics 1

($T_{amb} = 25^{\circ}\text{C}$, $V_{EE} = V_{SS} = 0\text{V}$, $t_r, t_f \leq 20\text{ns}$, $C_L = 50\text{pF}$, $R_L = 10\text{k}\Omega$, unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
HIGH to LOW propagation delay time	t_{PHL}	Yn to Z; Z to Yn; see Figure 6	$V_{DD} = 5\text{V}$	-	10	ns
			$V_{DD} = 9\text{V}$	-	5	ns
		Sn to Yn, Z; see Figure 7	$V_{DD} = 5\text{V}$	-	150	ns
			$V_{DD} = 9\text{V}$	-	65	ns
LOW to HIGH propagation delay	t_{PLH}	Yn to Z; Z to Yn; see Figure 6	$V_{DD} = 5\text{V}$	-	10	ns
			$V_{DD} = 9\text{V}$	-	5	ns
		Sn to Yn, Z; see Figure 7	$V_{DD} = 5\text{V}$	-	150	ns
			$V_{DD} = 9\text{V}$	-	75	ns
HIGH to OFF-state propagation delay	t_{PHZ}	$\bar{E}$ to Yn, Z; see Figure 8	$V_{DD} = 5\text{V}$	-	95	ns
			$V_{DD} = 9\text{V}$	-	90	ns
LOW to OFF-state propagation delay	t_{PLZ}	$\bar{E}$ to Yn, Z; see Figure 8	$V_{DD} = 5\text{V}$	-	100	ns
			$V_{DD} = 9\text{V}$	-	90	ns
OFF-state to HIGH propagation delay	t_{PZH}	$\bar{E}$ to Yn, Z; see Figure 8	$V_{DD} = 5\text{V}$	-	130	ns
			$V_{DD} = 9\text{V}$	-	55	ns
OFF-state to LOW propagation delay	t_{PZL}	$\bar{E}$ to Yn, Z; see Figure 8	$V_{DD} = 5\text{V}$	-	120	ns
			$V_{DD} = 9\text{V}$	-	50	ns



3.3.4、AC Characteristics 2

($T_{amb}=25^{\circ}\text{C}$, $V_{EE}=V_{SS}=0\text{V}$, $V_I=0.5V_{DD}$ (p-p), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
Square wave distortion	d _{sin}	see Figure 9; R _L =10kΩ; C _L =15pF; channel ON; f _i =1kHz	V _{DD} =5V	0.25	-	-	%
			V _{DD} =9V	0.04	-	-	%
any two channel crosstalk	f _{ct}	V _{DD} =9V, see note2		1	-	-	MHz
crosstalk voltage ($\bar{E}$ to Sn or Yn to Z)	V _{ct}	see Figure 10; R _L =10kΩ; C _L =15pF; $\bar{E}$ or Sn=V _{DD} (square-wave)		50	-	-	mV
OFF frequency	f _{OFF}	V _{DD} =9V, see note3		1	-	-	MHz
conduction frequency	f _{ON}	V _{DD} =5V, see note4		13	-	-	MHz
		V _{DD} =9V, see note4		40	-	-	MHz

Note:

[1] f_i is biased at $0.5V_{DD}$; $V_I=0.5V_{DD}$ (p-p).

[2] $R_L=1\text{k}\Omega$; $20\log V_{os}/V_{is}=-50\text{dB}$, see Figure 11.

[3] $R_L=1\text{k}\Omega$; $C_L=5\text{pF}$, channel off, $20\log V_{os}/V_{is}=-50\text{dB}$, see Figure 9.

[4] $R_L=1\text{k}\Omega$; $C_L=5\text{pF}$, channel on, $20\log V_{os}/V_{is}=-3\text{dB}$, see Figure 9.

4、Testing Circuit

4.1、AC Testing Circuit 1

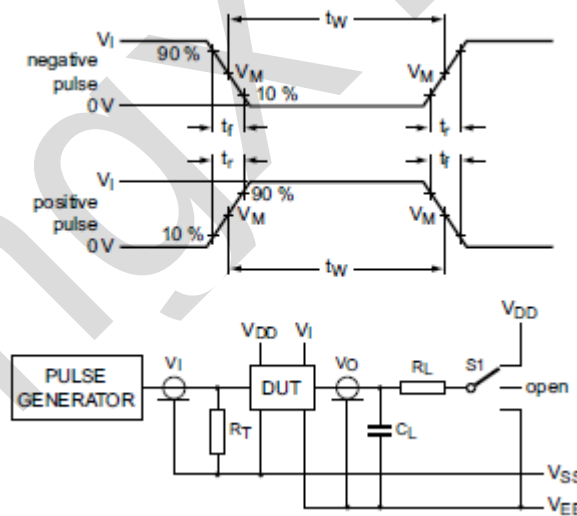


Figure 5. Test circuit for switching times

Definitions for test circuit:

DUT=Device Under Test.

C_L =Load capacitance including jig and probe capacitance.

R_T =Termination resistance should be equal to the output impedance Z_o of the pulse generator.

R_L =Load resistance.

4.2、AC Testing Waveforms

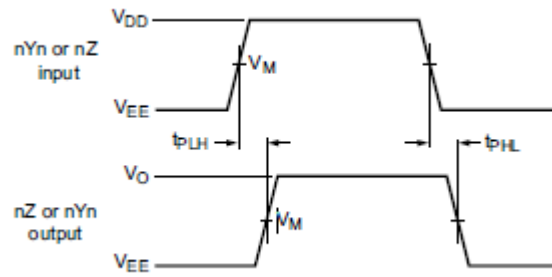


Figure 6. nYn, nZ to nZ, nYn propagation delays

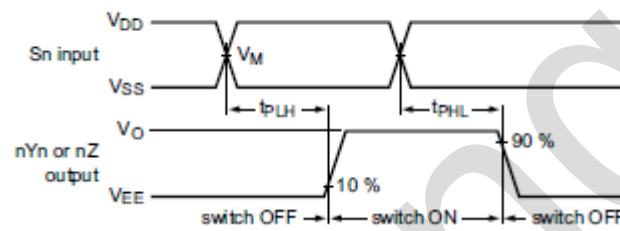


Figure 7. Sn to nYn, nZ propagation delays

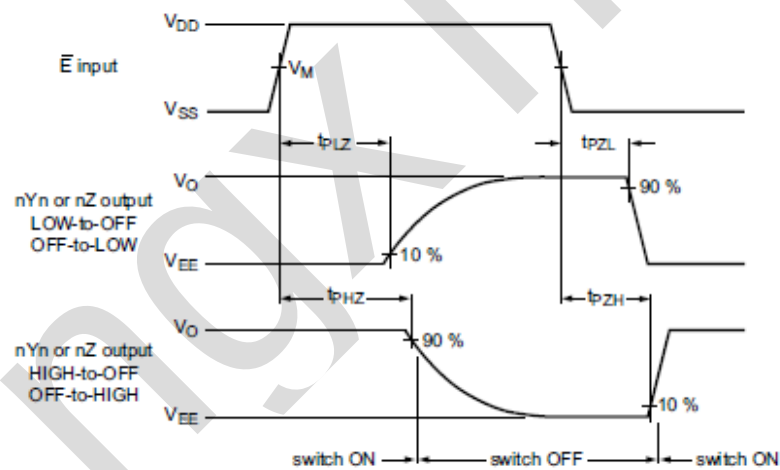


Figure 8. Enable and disable times

4.3、AC Testing Circuit 2

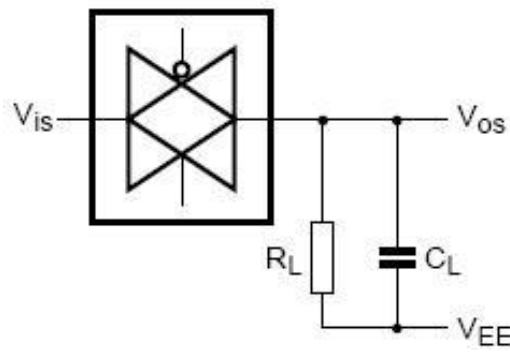


Figure 9. Square wave distortion degree of cut-off frequency and conduction frequency test pattern

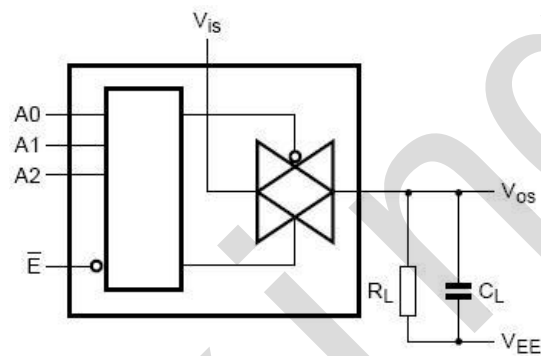


Figure 10. Crosstalk logical input/output test

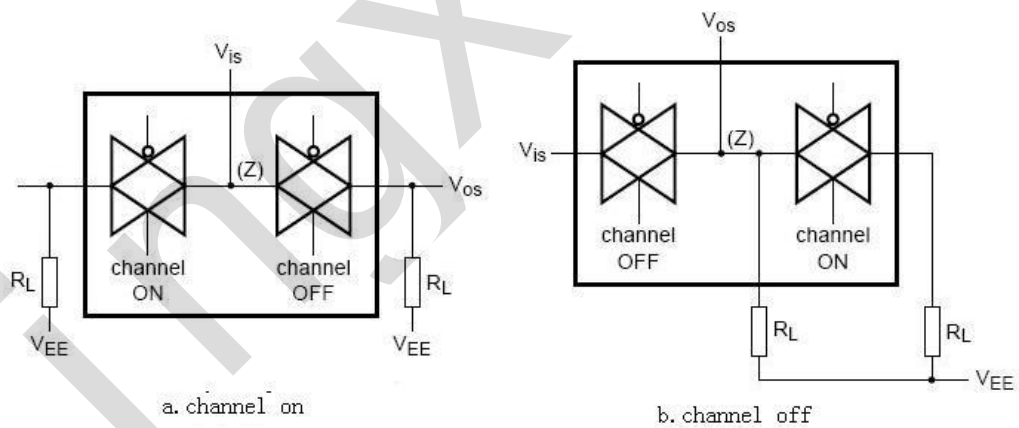


Figure 11. Inter channel Crosstalk

4.4、On Resistance Waveform And Test Circuit

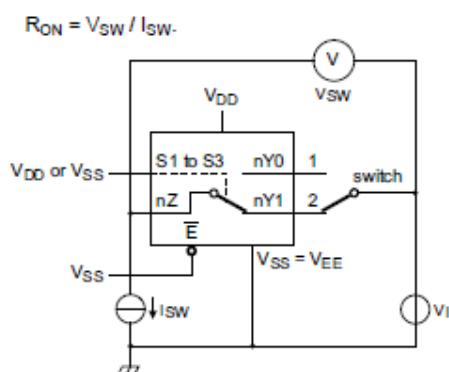


Figure 12. Test circuit for measuring R_{ON}

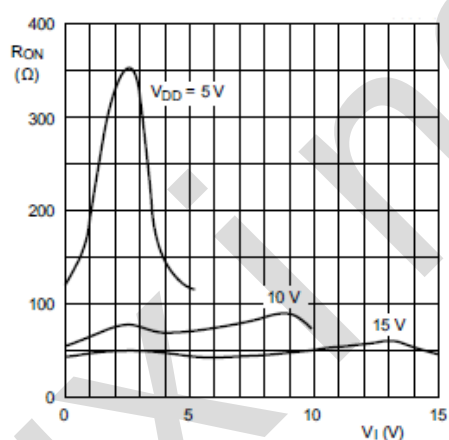


Figure 13. Typical R_{ON} as a function of input voltage

4.5、Measurement Points

Supply voltage	Input	Output
V_{DD}	V_M	V_M
3V to 9V	$0.5 \times V_{DD}$	$0.5 \times V_{DD}$

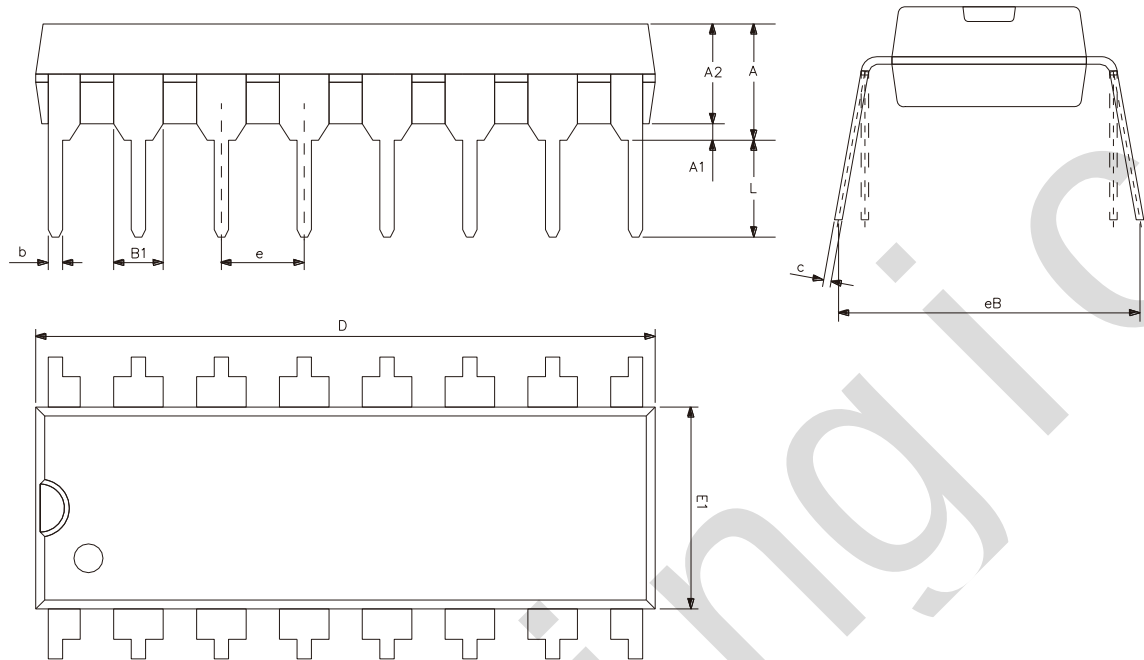
4.6、Test Data

Test	Input		Load		Switch
	V_{is}	t_r, t_f	C_L	R_L	
t_{PHL}	V_{EE}	20ns	50pF	10kΩ	V_{DD}
t_{PLH}	V_{DD}	20ns	50pF	10kΩ	V_{EE}
t_{PZH}, t_{PHZ}	V_{DD}	20ns	50pF	10kΩ	V_{EE}
t_{PZL}, t_{PLZ}	V_{EE}	20ns	50pF	10kΩ	V_{DD}
others	pulse	20ns	50pF	10kΩ	open



5、Package Information

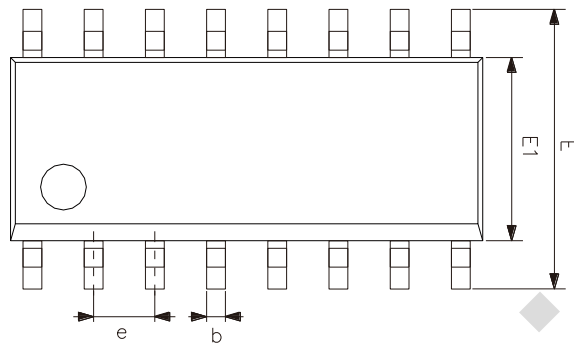
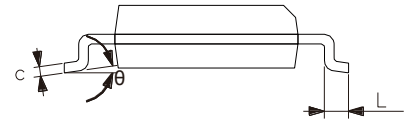
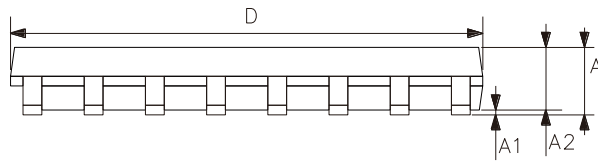
5.1、DIP16



Symbol	Dimensions (mm)	
	Min.	Max.
A2	3.20	3.60
A1	0.51	-
A	3.60	5.33
L	3.00	3.60
b	0.36	0.56
B1	1.52	
D	18.80	19.94
E1	6.20	6.60
e	2.54	
c	0.20	0.36
eB	7.62	9.30



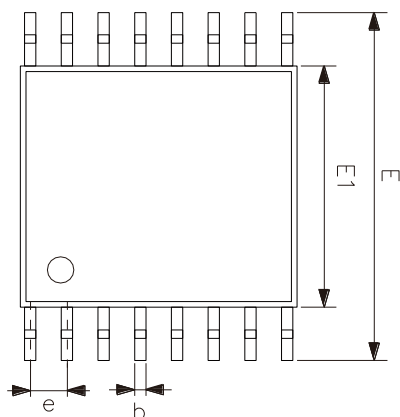
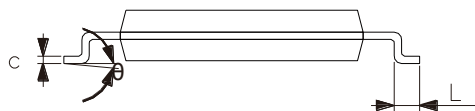
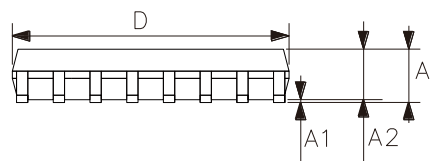
5.2、SOP16



Symbol	Dimensions (mm)	
	Min.	Max.
A	1.35	1.80
A1	0.10	0.25
A2	1.25	1.55
b	0.33	0.51
c	0.19	0.25
D	9.50	10.10
E	5.80	6.30
E1	3.70	4.10
e	1.27	
L	0.35	0.89
θ	0°	8°



5.3、TSSOP16



Symbol	Dimensions (mm)	
	Min.	Max.
A	-	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	4.90	5.10
E1	4.30	4.50
E	6.20	6.60
e	0.65	
L	0.45	0.75
θ	0°	8°



6、Statements And Notes

6.1、The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									

6.2、Notes

We Recommend you to read this chapter carefully before using this product.

The information in this chapter is provided for reference only and Lingxing disclaims any express or implied warranties, including but not limited to applicability, special application or non-infringement of third party rights.

This product is not suitable for critical equipment such as life-saving, life-sustaining or safety equipment. It is also not suitable for applications that may result in personal injury, death, or serious property or environmental damage due to product malfunction or failure. Lingxing will not be liable for any damages incurred by the customers at their own risk for such applications.

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